

Trends in Optical Interconnects: Size, Power, Cost

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Outline

GigOptix and the HX Line
A new SFP+ solution
Conclusions

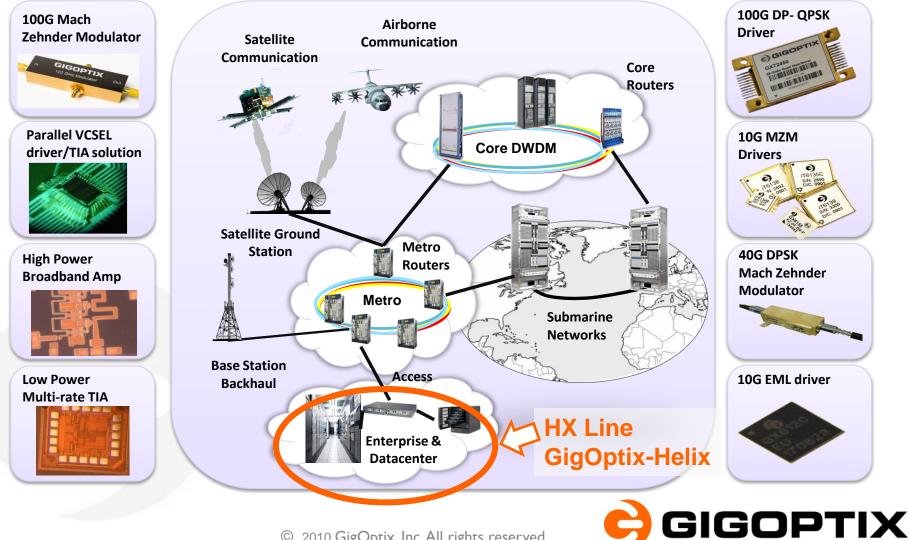


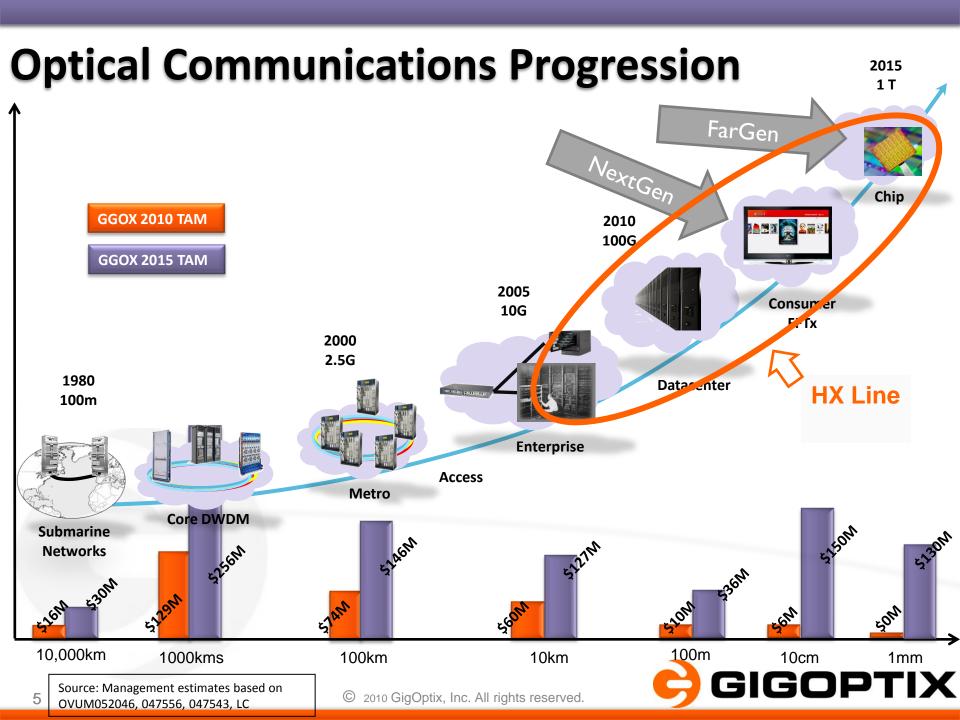
GigOptix and the HX Line



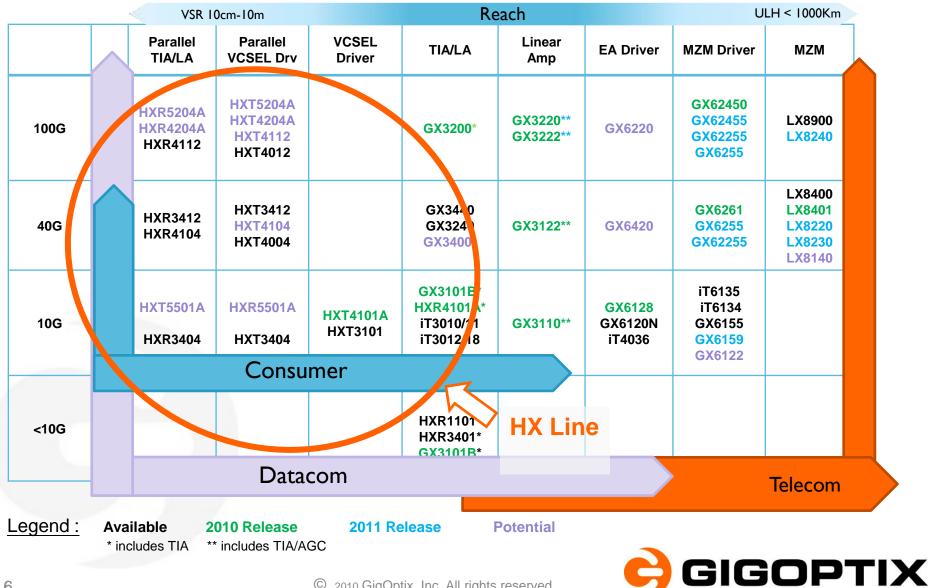
GigOptix Markets

GigOptix addresses multiple applications across the global network





Optical PMD Product Portfolio Overview



Parallel Optical Modules

De-facto standards (MSA's):

SNAP12 / CXP

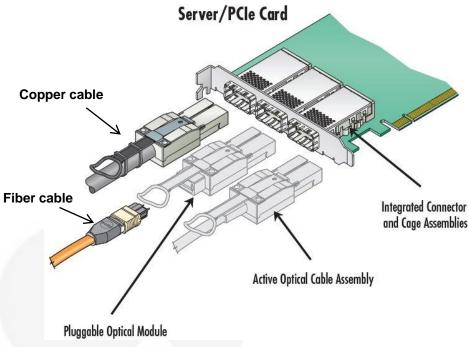
QSFP

Other



Active Optical Cables (AOC)

Datacom Examples: QSFP, CXP



From: http://www.molex.com/cmc_upload/0/000/-15/805/DS_iPass_HSC_CXP.pdf

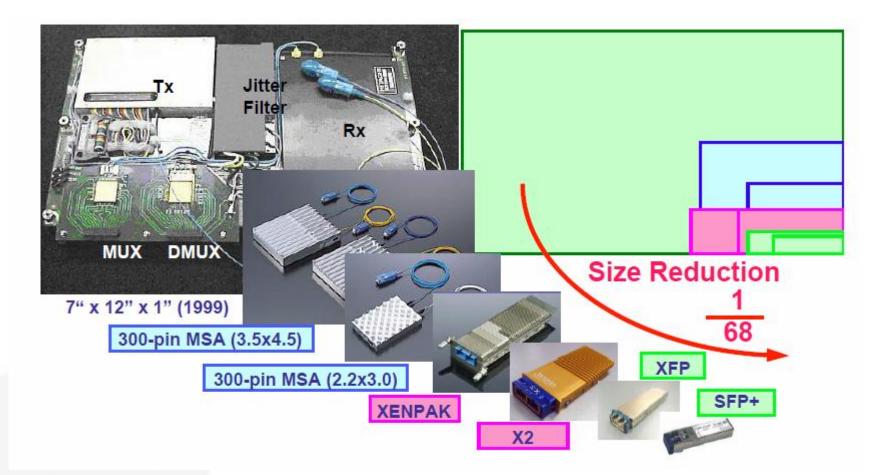
Consumer Example: HDMI/DVI



From: http://www.opticis.com/english/02_product/product01_01.htm#



10G History – MSA Evolution

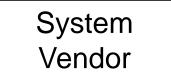


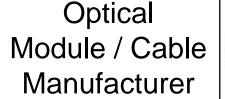
Evolved towards smaller solutions



Fab-less Chip Vendor

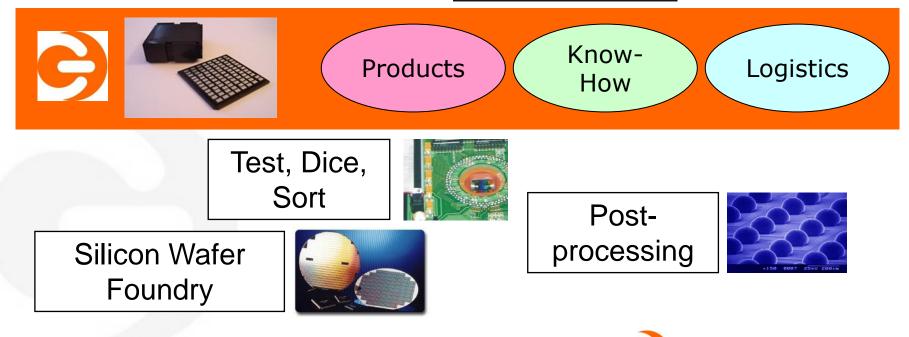
GigOptix forms the supply-chain interface between "silicon" world and "optical" world







ΧΙΤ

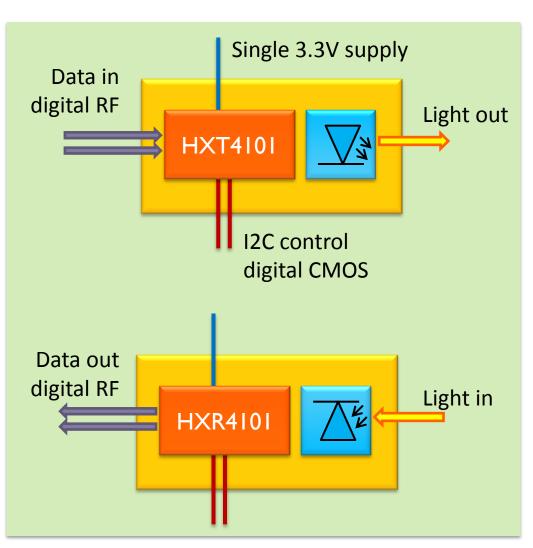


A new SFP+ solution



The Smart OSA Concept

- GigOptix' Smart OSA's consist of one Silicon chip and one O/E chip
- All high speed and analog electronics is integrated, only standard digital interfaces
 - Simplified design
 - Improved RF performance
 - Lower power dissipation
 - Lower EMI





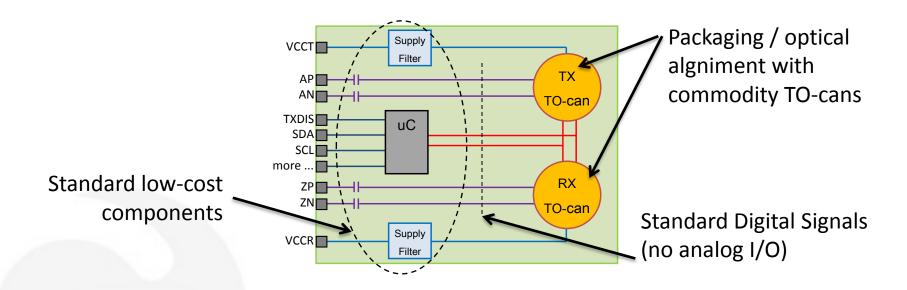
The HXT4101 / HXR4101 Chipset: Overview

- The chipset is made of:
 - The HXT4101A 14 Gb/s Compact VCSEL Driver
 - The HXR4101A 4.0 G / 14 Gb/s Dual-Band Limiting TIA
- Common Feature Set
 - Configuration via I2C, or selection of predefined modes via wirebonds
 - Lowest power dissipation vs performance
 - 100mW for consumer applications
 - 150mW 100m links
 - 250mW 300m links
 - Small Form Factor
 - Minimal external components required
 - Small die size: ~1mm x 1mm
 - Speed up to 14 Gb/s
 - On-chip A/D Converter for control and diagnostic read-outs



Example: Green SFP+ Module using Smart OSA's

GigOptix[™] SFP+ VSR (Very Short Reach) format will cover most frequently used reaches (up to 100m) in Datacenter/HPC while consuming merely 150mW. That is **4x** lower power dissipation per plug than current SFP+ products.



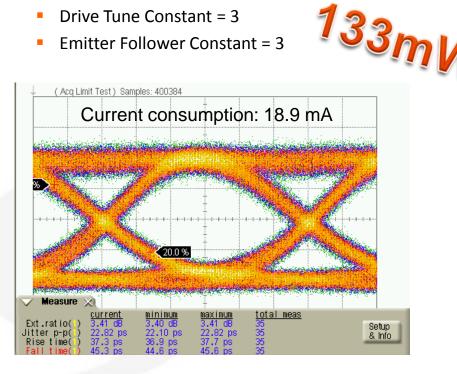
GigOptix owns the chipset, the firmware and is deeply involved in the module design, CM selection, O/E selection, production setup and monitoring.

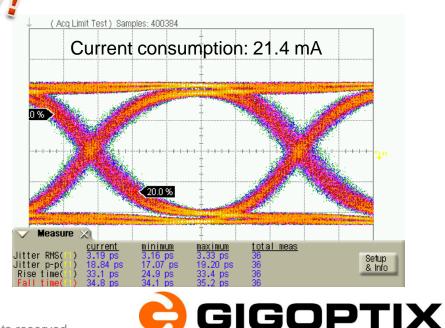


Low Power Consumption 10.3 Gbit/s Link

- HXT4101A Settings:
 - **Driving Current:**
 - Average = 25 (5.2 mA)
 - Modulation = 25 (5.2 mA_{pp})
 - Pulse Width Adjust = 2
 - Bandwidth Adjust = 0
 - Drive Tune Constant = 3
 - Emitter Follower Constant = 3

- HXR4101A Settings:
 - Signal detection & AGC disabled
 - Swing Size = 0
 - Emitter follower current = 0
 - Gain = 0
 - Output Degeneration = 3
 - TIA bandwidth = 0
 - EF current (output) = 1





TOSA/ROSA Product map

	TOSA 5pin (HXT4101A in stand-alone mode)	TOSA 6pin (HXT4101A in 12C- controlled mode)	ROSA 5pin (HXR4101A in stand-alone mode)	ROSA 6pin (HXR4101A in I2C- controlled mode)
Datacom		X Smart OSA	X Conventional usage	X Smart OSA
Consumer	Х	X ¹⁾	Х	X ¹⁾
Avionics	X ²⁾		Х	
Telecom				X long-wavelength SM I2C to set bit-slicing

Notes:

1) Advanced consumer applications, e.g. to save power or wide temperature range

2) Avionics may need special TX subassemblies to cover very large temperature range while avoiding the use of a microcontroller



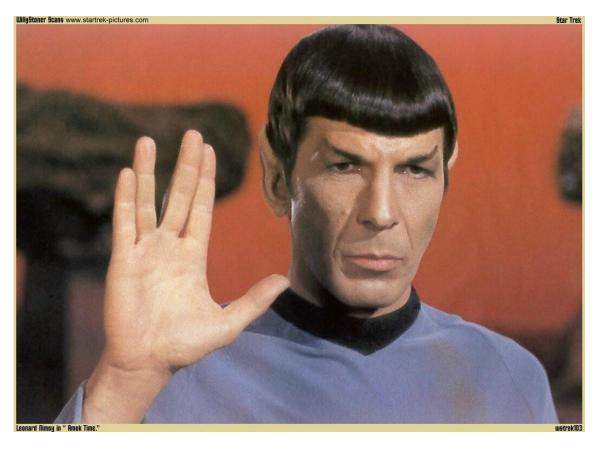


Conclusions

- GigOptix chip-sets enable ever more compact assemblies of optical interconnect solutions
- Smaller <u>sized</u> packages require more careful design
 - Cooperation with contract manufacturers
 - OSA products
- Lower <u>power</u> and <u>cost</u> reduction through reduction of interfaces / integration of functionality
- Create end-customer pull to accelerate time-to-market



SPOC!



<u>S</u>ize, <u>Power</u>, <u>C</u>ost

The 5 year mission starts here ...

